

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT7817960

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JENS STEENSTRUP	07/02/2021
CHRISTOPHER TIEMANN	07/02/2021
MARK CHUN	07/02/2021
KIRK HOBART	07/02/2021
RECEIVING PARTY DATA	
Name:	R2SONIC, LLC
Street Address:	5307 INDUSTRIAL OAKS BLVD. #120
City:	AUSTIN
State/Country:	TEXAS
Postal Code:	78735
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17671717
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ATTORNEY DOCKET NUMBER:	OUT-22002
NAME OF SUBMITTER:	PAUL D. CHANCELLOR
SIGNATURE:	/paul d. chancellor/
DATE SIGNED:	02/27/2023
Total Attachments: 2	
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source=OUT-22002_signed_assignment#page2.tif	

PATENT ASSIGNMENT

WHEREAS, Jens Steenstrup residing in Austin, Texas; Christopher Tiemann residing in Austin, Texas; Mark Chun residing in Austin, Texas; and Kirk Hobart residing in Austin, Texas ("Assignors") are the sole inventor of new and useful 1) ACOUSTIC DOPPLER SYSTEM AND METHOD identified as U.S. patent application no. 16/844,609 filed April 9, 2020 and 2) MULTIFAN SURVEY SYSTEM AND METHOD identified as U.S. patent application no. 16/864,252 filed May 1, 2020 ("Inventions"); and

WHEREAS, R2SONIC, LLC, a Delaware LLC, of 5307 Industrial Oaks Blvd. #120; Austin, Texas 78735 ("Assignee"), desires to acquire by formal, recordable assignment the entire right, title and interest in and to the Inventions, the applications, and any Patent(s) that might be granted for the Inventions in the United States and throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, Assignors hereby sell, assign and transfer to Assignee, their entire right, title and interest in and to the Inventions, these applications, any application(s) claiming the benefit of these applications, and any Patent(s) that might be granted for the Inventions in the United States and throughout the world, including the right to file applications directly in the name of Assignee and to claim for any such applications any priority rights to which such application(s) are entitled under applicable laws, conventions, treaties or otherwise.

Further, Assignors agree that, upon request and without further compensation, but at no expense to Assignor, they and their legal representatives and assigns will perform all lawful acts, including the execution of papers and the giving of testimony, that might be necessary or desirable for obtaining, sustaining, reissuing or enforcing Patent(s) in the United States and throughout the world for the Inventions, and for perfecting, recording or maintaining the title of Assignee, its successors and assigns, to the Inventions, the application(s), and any Patent(s) granted for the Inventions in the United States and throughout the world.

Assignors represent and warrant that they have not granted and will not grant to others any rights inconsistent with the rights granted by this Assignment.

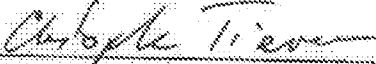
Assignment to R2SONIC, LLC

IN WITNESS WHEREOF, Assignors have executed this Assignment.

Date: 7/2/2021


Jens Steenstrup, Inventor


Date: 7/2/21


Christopher Tiemann, Inventor

Date: 2 JULY 2021


Mark Chun, Inventor

Date: 2-JULY-2021


Kirk Hobart, Inventor

IN WITNESS WHEREOF, Assignee has executed this Assignment.

Date: 7/2/2021


Yating Lai
President, R2SONIC, LLC